

Introduction

This application note applies to the following IDT PCIe® 2.0 (Gen2) Switch Devices: IDT89HPES16T4G2 and IDT89HPES12T3G2. A few of the older Gen1 endpoint devices are unable to interoperate with Gen2 link partners including IDT Gen2 switches. This document explains the issue and a proposed solution.

Issue and Solution

IDT has discovered that a few of the PCIe 1.0a/1.1 (Gen1) base specification compliant devices/adapters fail physical layer interoperability with IDT PCIe 2.0 (Gen2) switches PES16T4G2 and PES12T3G2.

The root cause of this incompatibility is a flaw in the design of the endpoint devices and not the IDT switch. Newer revisions of these endpoints available from some vendors are known to have removed the design flaw. Users are encouraged to work with the endpoint vendors to obtain additional details regarding the design flaw and to update their hardware.

IDT has confirmed that the following endpoint devices do not interoperate successfully with the IDT Gen2 switches:

| Card/HBA/Adapter | Chip ID | Board Label | Vendor | Device | Sub | Rev | Fixed ¹ |
|------------------------|------------------------------|-------------------------------------|--------|--------|------|-----|--------------------------------------|
| Agilent HHBA-6420C-S02 | HPFC-6400C | PMCB00256 - 5288-5836 Rev 3 | 15BC | 0103 | | | |
| Agilent HHBA-6600 | Tachyon QE4 HPFC-6600A | IOSD-0008V-30-0614-00023 (Rev 3) | 15BC | 1200 | 0000 | 04 | |
| PMC HPFC-6700C-P | Tachyon DE4 HPFC-6700C-P | IOSD-0012V-30-0628-00011 (Rev 4) | 15BC | 1203 | 0000 | 06 | |
| LSI 7104EP-LC | | LSI7104EP-LC L3-00113-01D | 1000 | 0646 | 5010 | 01 | 02 |
| LSI 7204EP-LC | NA | LSI7204EP-LC L3-00120-01D | 1000 | 0646 | 1020 | 01 | 02 |
| LSI SAS3041E | LSI SAS1064E B1 | 03-01101-02B | 1000 | 0056 | 3090 | 02 | 08 |
| LSI SAS3801E | NA | L3-01123001B | 1000 | 0058 | 30A0 | 02 | 08 |
| HP Smart Array P400 | LSI SAS1078 B0 | NA | 103C | 3230 | 3234 | 01 | |
| Xilinx ML 555 | Xilinx Virtex-5 XC5VLX50T | ML555 0431438 REV03 | 10EE | 5050 | | | New bit-stream available from Xilinx |
| Syskonnet SK-9E21D | Marvel 88E8052- NNC | 60-10-088-001 | 1148 | 9E00 | 21D0 | 10 | |
| Syskonnet SK-9E22 | Marvel 88E8062- BDS | NA | 1148 | 9E00 | 2200 | 12 | |

¹. Silicon revision at which the vendor achieved PCIe 2.0 interoperability. An empty cell in this column implies that IDT has not been able to check for updates with the vendor. Users are encouraged to check on their own.

It is possible to put in place a workaround for the interoperability problem seen with some of the older PCIe Gen1 endpoints. This workaround can be implemented in the system firmware (BIOS).

The basic logic behind the workaround, applied to each downstream port of the IDT switch, is as follows:

- Step 1: Check to see if the port has link-trained with the partner. If link-trained, no workaround is required, implying that link partner is a Gen2 device or a properly designed Gen1 device.
- Step 2: If not link-trained, determine if the port has no link partner at all, or if it is a problematic Gen1 link partner.
- Step 3: Force the switch downstream port to Gen1 link speed and check if the link can train.
- Step 4: If the link does not train, the implication is that the link has no link partner at all. If the link trains, the implication is that the link partner is one of the problematic endpoints and the workaround has resolved the issue.

Here is some pseudo code to implement this logic (it requires firmware to modify the PCIe configuration space of the IDT switch downstream ports):

```

loop till all ports are tested
{
  if pcielsts.dllla == 1;          /* bit 13 at configuration space offset 0x052 for the port; implies Data Link Layer is active; link-trained */
    "done with this port";        /* good Gen1 or Gen2 link partner detected and operational */
  else                             /* either no link partner at all, or problematic Gen1 link partner */
  {
    pcielctl.hawd = 1;            /* bit 9 at configuration space offset 0x050 for the port; This step is required only for revision ZA silicon.
                                   Not required for revision ZB silicon, but no adverse effect even if done to revision ZB silicon. */
    pcielctl2.tls = 1;            /* bits 3:0 at configuration space offset 0x070 for the port; forces Gen1 link speed */
    pcielctl.ldis = 1;            /* bit 4 at configuration space offset 0x050 for the port; disables the link */
    delay (10 milliseconds);      /* allows the link to go down */
    pcielctl.ldis = 0;            /* bring up the link */
    delay (100 milliseconds);     /* allows the link to be back up */
    if pcielsts.dllla == 1;        /* bit 13 at configuration space offset 0x052 for the port; implies Data Link Layer is active; link-trained */
      "done with this port";      /* problematic Gen1 link partner detected and operational */
    else
      "no link partner"           /* unused port */
  }
}

```

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